

**2025 Utrecht**, J. Xu: An Ultra-Compact Ku-Band Doherty Power Amplifier with a Single-Footprint Triple Two-Turn Asymmetric Combiner for 6G FR3

J. Xu, E. Liu, M. Eleraky, T.-Y. Huang, C. Chu, H. Wang

**2025 Utrecht**, P. Umbach: Resistive D-Band Mixers with Monolithic Integrated Broadband IF Balun and LO Amplifier

P. Umbach, F. Thome, A. Leuther, R. Quay

**2024 Paris**, M. Wittlinger: A Frequency-Agile Digital-to-RF Power Amplifier in 22 nm FD-SOI CMOS Technology

M. Wittlinger, M. Grözing, M. Berroth, G. Rademacher

**2024 Paris**, G. Kaval: A 100-114 GHz GaAs MMIC Power Amplifier with Fully Integrated Dynamic Gate Bias Control for Linearization and Efficiency Enhancement

G. Kaval, G. Lasser, M. Gavell, C. Fager

**2023 Berlin**, A. Elmenshawi: A 75-140 GHz Frequency Quadrupler with Milli-Watt Level Output Power in 22nm FDSOI

A. Elmenshawi, M.W. Mansha, S. Muralidharan, M.M. Hella

**2022 Milan**, A. Engelmann: Design of Two Low DC-Power High-Efficiency D-Band Power Amplifiers in 22nm FDSOI

A. Engelmann, P. Hetterle, F. Probst, R. Weigel, M. Dietz

**2021 London**, T. Braun: A low Phase Noise Phase-Locked Loop with Short Settling Times for Automotive Radar

T. Braun, M. van Delden, C. Bredendiek, J. Schoepfel, N. Pohl

**2020 Utrecht**, T. Singh: Reconfigurable PCM GeTe-Based Latching 6-Bit Digital Switched Capacitor Bank

T. Singh, R.R. Mansour

**2019 Paris**, L. Nyssens: Effective Resistivity Extraction of Low-Loss Silicon Substrate at Millimeter-Wave Frequencies

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**2018 Madrid**, A. Piacibello: Design of an S-Band Chireix Outphasing Power Amplifier Based on a Systematic Bandwidth Limitation Analysis

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X. Yang, X. Xu, Z. Sun, T. Shibata, T. Yoshimasu

2014 Rome, C. Tzschoppe: A 2.4 GHz Fast Switchable LNA with Transformer Matching for Wireless Wake-Up Receivers

C. Tzschoppe, R. Kostack, J. Wagner, R. Paulo, F. Ellinger

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